

Part Number: XZFMDK10C2

SURFACE MOUNT DISPLAY

Features

- 0.4 inch digit height
- Robust package
- Low power consumption
- Standard configuration: Gray face w/ white
- Standard Package: 250pcs/ Reel • MSL (Moisture Sensitivity Level): 2a
- RoHS Compliant

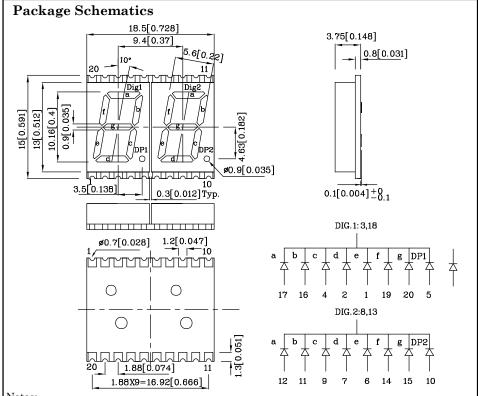






ATTENTION OBSERVE PRECAUTIONS FOR HANDLING

ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. Specifications are subject to change without notice.
- 3. The gap between the reflector and PCB shall not exceed 0.25mm.

Absolute Maximum Ratings (T _A =25°C)	Red (AlGaInP)	Unit		
Reverse Voltage		5	V	
Forward Current I		30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width		185	mA	
Power Dissipation	P_{D}	75	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	C	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Red (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =10mA)	V_{F}	1.85	V	
Forward Voltage (Max.) (I _F =10mA)	V_{F}	2.5	V	
Reverse Current (Max.) (V _R =5V)	I_R	10	uA	
Wavelength of Peak Emission CIE127-2007* (Typ.) $(I_F=10\text{mA})$	CIE127-2007* (Typ.) λP 645			
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=10\text{mA})$	λD	630*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	$\triangle \lambda$	28	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	pF	

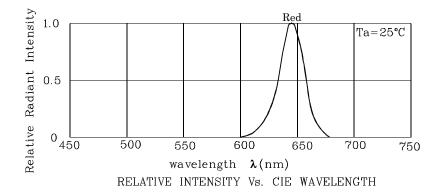
Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* $(I_F=10 \text{mA})$ ucd		Wavelength CIE127-2007* nm λP	Description
			min.	typ.		
XZFMDK10C2	Red	AlGaInP	21000 9000*	53990 19990*	645*	Common Cathode, Rt. Hand Decimal

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

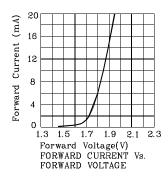
Oct 13,2016 XDSA9151 V7-X Layout: Maggie L.

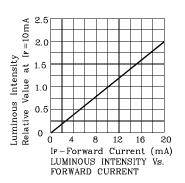


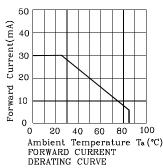


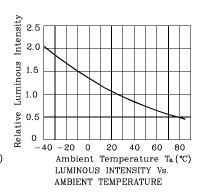


❖ Red



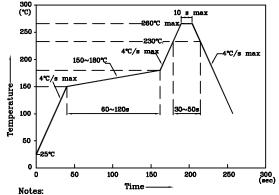






LED is recommended for reflow soldering and soldering profile is shown below.

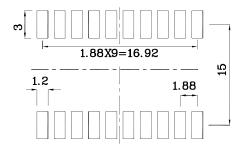
Reflow Soldering Profile for SMD Products (Pb-Free Components)



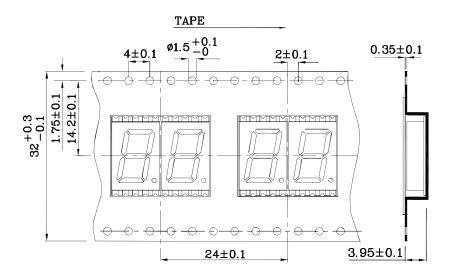
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions



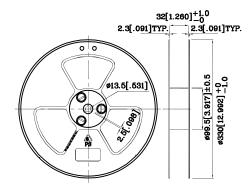
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ±0.15)



* Tape Specification (Units:mm)



* Reel Dimension



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

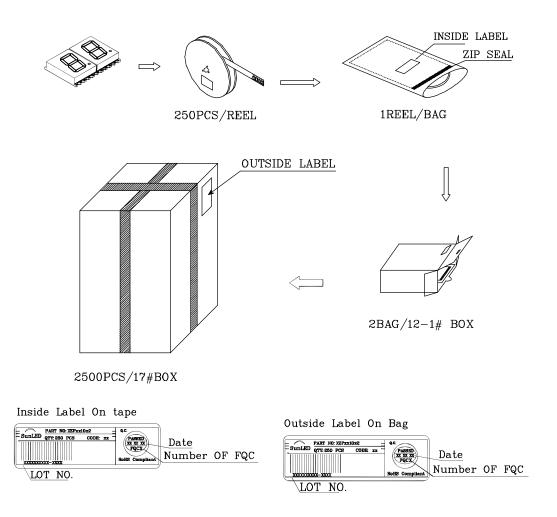
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

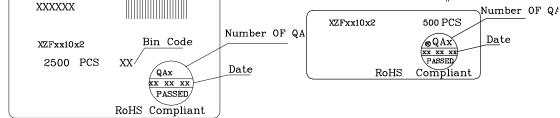




PACKING & LABEL SPECIFICATIONS







TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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